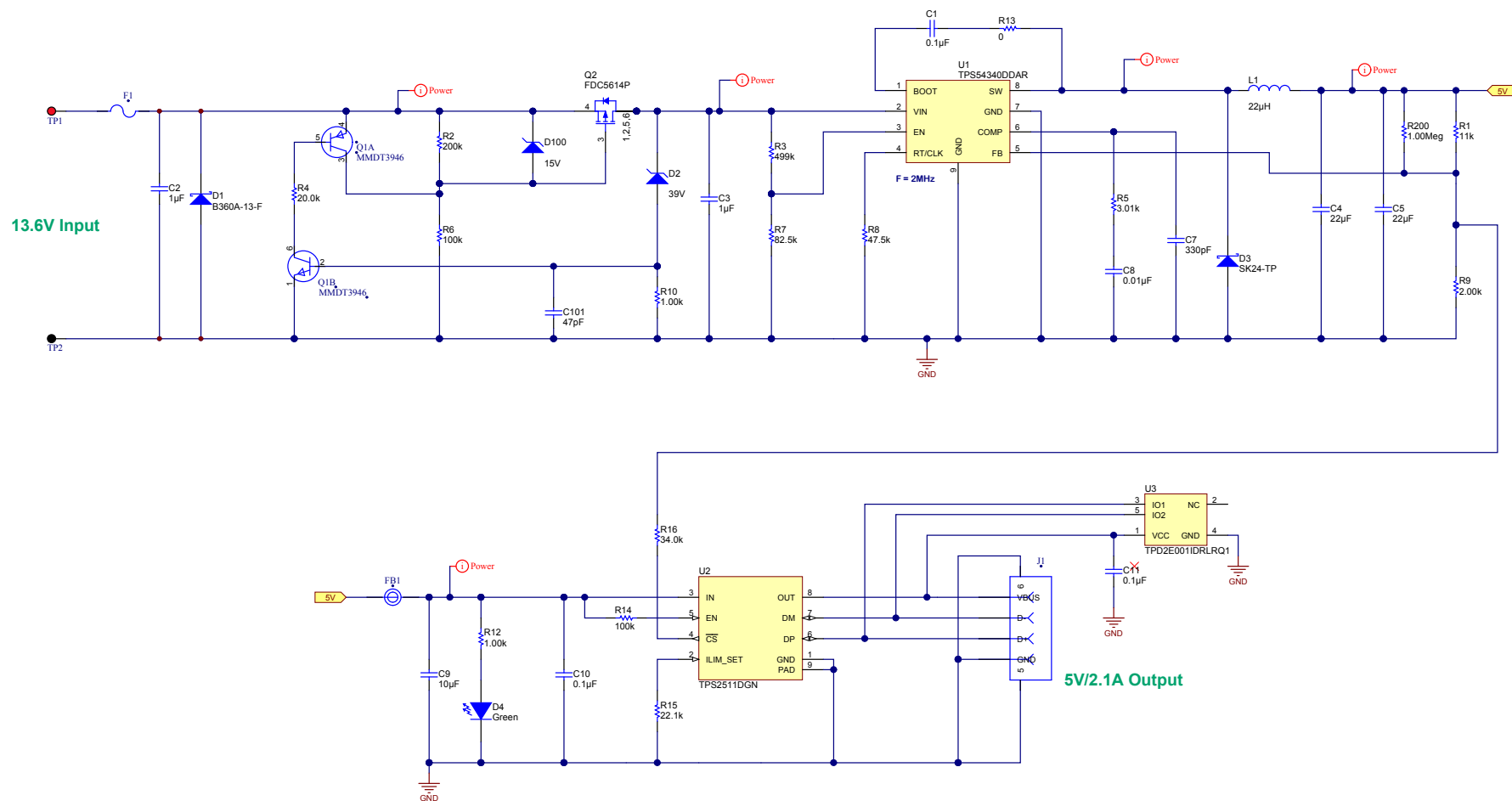


Notes:

1. Built on SAT0028 PWB.
2. R200 added for PMP8851.



PCB Number: PMP8851
PCB Rev: A

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Designed for:		Mod. Date: 3/25/2013	
Project Title: 5V/2A Automotive USB Charger		Rev. A	
Number: PMP8851		Sheet Title:	
SVN Rev: Not in version control		Assembly Variant: 001	
Drawn By:		File: PMP8851_REVAsheet1_SchDoc	
Engineer: B King		Contact: http://www.ti.com/support	
		Sheet: 1 of 1	
		Size: B	

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